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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PSMC, PWM, WDT
Number of I/O	35
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 14x12b; D/A 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1787-e-pt

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TABLE 3-12:	SPECIAL FUNCTION REGISTER SUMMARY	(CONTINUED))
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Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Ban	k 7										
38Ch	INLVLA	Input Type Cor	ntrol for POR	ΓA						0000 0000	0000 0000
38Dh	INLVLB	Input Type Cor	ntrol for POR	ГВ						0000 0000	0000 0000
38Eh	INLVLC	Input Type Cor	ntrol for POR	ГС						1111 1111	1111 1111
38Fh	INLVLD ⁽³⁾	Input Type Co	ntrol for POR	ГD						1111 1111	1111 1111
390h	INLVLE	—	_	_	_	INLVLE3	INLVLE2 ⁽³⁾	INLVLE1 ⁽³⁾	INLVLE0 ⁽³⁾	1111	1111
391h	IOCAP				IOCAP	<7:0>				0000 0000	0000 0000
392h	IOCAN				IOCAN	<7:0>				0000 0000	0000 0000
393h	IOCAF				IOCAF	<7:0>				0000 0000	0000 0000
394h	IOCBP				IOCBP	<7:0>				0000 0000	0000 0000
395h	IOCBN				IOCBN	<7:0>				0000 0000	0000 0000
396h	IOCBF				IOCBF	<7:0>				0000 0000	0000 0000
397h	IOCCP				IOCCP	<7:0>				0000 0000	0000 0000
398h	IOCCN				IOCCN	<7:0>				0000 0000	0000 0000
399h	IOCCF				IOCCF	<7:0>				0000 0000	0000 0000
39Ah		Linimalomento	d								
39Ch	—	Unimplemente	u							_	_
39Dh	IOCEP	— — — — IOCEP3 — — —							_	0	0
39Eh	IOCEN	IOCEN3							—	0	0
39Fh	IOCEF	IOCEF3							—	0	0
Ban	k 8-9					•				•	
40Ch											
or											

40Ch				
or				
41Fh				
and	_	Unimplemented	_	—
48Ch				
or				
49Fh				

Bank 10

Dan	K IU									
50Ch 510h	_	Unimplemente	d						_	—
511h	OPA1CON	OPA1EN	OPA1SP	—	—	_	_	OPA1PCH<1:0>	0000	0000
512h	—	Unimplemente	d						—	—
513h	OPA2CON	OPA2EN OPA2SP OPA2PCH<1:0>							0000	0000
514h	—	Unimplemente	d						—	—
515h	OPA3CON ⁽³⁾	OPA3EN	OPA3SP	_	_	_	_	OPA3PCH<1:0>	0000	0000
51Ah	CLKRCON	CLKREN CLKROE CLKRSLR CLKRDC<1:0> CLKRDIV<2:0>						0011 0000	0011 0000	
51Bh 51Fh	_	Unimplemente	d						_	_

x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved. Legend:

Shaded locations are unimplemented, read as '0'. 1: These registers can be addressed from any bank.

Note 2:

Unimplemented, read as '1'. 3:

PIC16(L)F1784/7 only. PIC16F1784/6/7 only. 4:

3.4 PCL and PCLATH

The Program Counter (PC) is 15 bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<14:8>) is not directly readable or writable and comes from PCLATH. On any Reset, the PC is cleared. Figure 3-4 shows the five situations for the loading of the PC.

FIGURE 3-4: LOADING OF PC IN DIFFERENT SITUATIONS



3.4.1 MODIFYING PCL

Executing any instruction with the PCL register as the destination simultaneously causes the Program Counter PC<14:8> bits (PCH) to be replaced by the contents of the PCLATH register. This allows the entire contents of the program counter to be changed by writing the desired upper 7 bits to the PCLATH register. When the lower 8 bits are written to the PCL register, all 15 bits of the program counter will change to the values contained in the PCLATH register.

3.4.2 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When performing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block). Refer to Application Note AN556, *"Implementing a Table Read"* (DS00556).

3.4.3 COMPUTED FUNCTION CALLS

A computed function CALL allows programs to maintain tables of functions and provide another way to execute state machines or look-up tables. When performing a table read using a computed function CALL, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block).

If using the CALL instruction, the PCH<2:0> and PCL registers are loaded with the operand of the CALL instruction. PCH<6:3> is loaded with PCLATH<6:3>.

The CALLW instruction enables computed calls by combining PCLATH and W to form the destination address. A computed CALLW is accomplished by loading the W register with the desired address and executing CALLW. The PCL register is loaded with the value of W and PCH is loaded with PCLATH.

3.4.4 BRANCHING

The branching instructions add an offset to the PC. This allows relocatable code and code that crosses page boundaries. There are two forms of branching, BRW and BRA. The PC will have incremented to fetch the next instruction in both cases. When using either branching instruction, a PCL memory boundary may be crossed.

If using BRW, load the W register with the desired unsigned address and execute BRW. The entire PC will be loaded with the address PC + 1 + W.

If using BRA, the entire PC will be loaded with PC + 1 +, the signed value of the operand of the BRA instruction.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BORCON	SBOREN	BORFS	_		_		_	BORRDY	61
PCON	STKOVF	STKUNF		RWDT	RMCLR	RI	POR	BOR	65
STATUS	_	_	_	TO	PD	Z	DC	С	27
WDTCON	_		WDTPS<4:0>					SWDTEN	110

TABLE 5-5: SUMMARY OF REGISTERS ASSOCIATED WITH RESETS

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by Resets.

REGISTER 13-2: APFCON2: ALTERNATE PIN FUNCTION CONTROL 2 REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0		
—	—	—	—	—	_	—	CCP3SEL		
bit 7							bit 0		
Legend:									
R = Readable bit	t	W = Writable bi	t	U = Unimpleme	ented bit, read as	'0'			
u = bit is unchan	ged	x = Bit is unkno	wn	-n/n = Value at POR and BOR/Value at all other Resets					
'1' = Bit is set		'0' = Bit is clear	ed						
bit 7-1	Unimplemente	d: Read as '0'							
bit 0	CCP3SEL: CCF	P3 Input/Output I	Pin Selection bit	t					
	1 = CCP3 is o	n pin RB5							
	PIC16(L)F1786	devices:							
	0 = CCP3	3 is on pin RC6							
PIC16(L)F1784/7 devices:									
	0 = CCP3	3 is on pin RE0							

REGISTER 13-31: ODCOND: PORTD OPEN DRAIN CONTROL REGIS	ſER
--	-----

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0		
ODD7	ODD6	ODD5	ODD4	ODD3	ODD2	ODD1	ODD0		
bit 7							bit 0		
Legend:									
R = Readable	bit	W = Writable	bit	U = Unimplemented bit, read as '0'					
u = Bit is unchanged x = Bit is unknown				-n/n = Value at POR and BOR/Value at all other Resets					

'1' = Bit is set	'0' = Bit is cleared

bit 7-0 ODD<7:0>: PORTD Open Drain Enable bits

For RD<7:0> pins, respectively

1 = Port pin operates as open-drain drive (sink current only)

0 = Port pin operates as standard push-pull drive (source and sink current)

REGISTER 13-32: SLRCOND: PORTD SLEW RATE CONTROL REGISTER

| R/W-1/1 |
|---------|---------|---------|---------|---------|---------|---------|---------|
| SLRD7 | SLRD6 | SLRD5 | SLRD4 | SLRD3 | SLRD2 | SLRD1 | SLRD0 |
| bit 7 | | | • | | | • | bit 0 |

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 SLRD<7:0>: PORTD Slew Rate Enable bits For RD<7:0> pins, respectively 1 = Port pin slew rate is limited 0 = Port pin slews at maximum rate

REGISTER 13-33: INLVLD: PORTD INPUT LEVEL CONTROL REGISTER

| R/W-1/1 |
|---------|---------|---------|---------|---------|---------|---------|---------|
| INLVLD7 | INLVLD6 | INLVLD5 | INLVLD4 | INLVLD3 | INLVLD2 | INLVLD1 | INLVLD0 |
| bit 7 | | | | | | | bit 0 |

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0

INLVLD<7:0>: PORTD Input Level Select bits

For RD<7:0> pins, respectively

1 = ST input used for PORT reads and interrupt-on-change

0 = TTL input used for PORT reads and interrupt-on-change

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELD	—	—	—	—	—	ANSD2	ANSD1	ANSD0	147
INLVLD	INLVLD7	INLVLD6	INLVLD5	INLVLD4	INLVLD3	INLVLD2	INLVLD1	INLVLD0	148
LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	146
ODCOND	ODD7	ODD6	ODD5	ODD4	ODD3	ODD2	ODD1	ODD0	148
PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	146
SLRCOND	SLRD7	SLRD6	SLRD5	SLRD4	SLRD3	SLRD2	SLRD1	SLRD0	148
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	146
WPUD	WPUD7	WPUD6	WPUD5	WPUD4	WPUD3	WPUD2	WPUD1	WPUD0	147

TABLE 13-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTD.

16.0 TEMPERATURE INDICATOR MODULE

This family of devices is equipped with a temperature circuit designed to measure the operating temperature of the silicon die. The circuit's range of operating temperature falls between -40°C and +85°C. The output is a voltage that is proportional to the device temperature. The output of the temperature indicator is internally connected to the device ADC.

The circuit may be used as a temperature threshold detector or a more accurate temperature indicator, depending on the level of calibration performed. A one-point calibration allows the circuit to indicate a temperature closely surrounding that point. A two-point calibration allows the circuit to sense the entire range of temperature more accurately. Reference Application Note AN1333, "Use and Calibration of the Internal Temperature Indicator" (DS01333) for more details regarding the calibration process.

16.1 Circuit Operation

Figure 16-1 shows a simplified block diagram of the temperature circuit. The proportional voltage output is achieved by measuring the forward voltage drop across multiple silicon junctions.

Equation 16-1 describes the output characteristics of the temperature indicator.

EQUATION 16-1: VOUT RANGES

High Range: VOUT = VDD - 4VT

Low Range: VOUT = VDD - 2VT

The temperature sense circuit is integrated with the Fixed Voltage Reference (FVR) module. See **Section 15.0 "Fixed Voltage Reference (FVR)"** for more information.

The circuit is enabled by setting the TSEN bit of the FVRCON register. When disabled, the circuit draws no current.

The circuit operates in either high or low range. The high range, selected by setting the TSRNG bit of the FVRCON register, provides a wider output voltage. This provides more resolution over the temperature range, but may be less consistent from part to part. This range requires a higher bias voltage to operate and thus, a higher VDD is needed.

The low range is selected by clearing the TSRNG bit of the FVRCON register. The low range generates a lower voltage drop and thus, a lower bias voltage is needed to operate the circuit. The low range is provided for lowvoltage operation.

FIGURE 16-1: TEMPERATURE CIRCUIT DIAGRAM



16.2 Minimum Operating VDD

When the temperature circuit is operated in low range, the device may be operated at any operating voltage that is within specifications.

When the temperature circuit is operated in high range, the device operating voltage, VDD, must be high enough to ensure that the temperature circuit is correctly biased.

Table 16-1 shows the recommended minimum $V \mbox{\scriptsize DD}$ vs. range setting.

TABLE 16-1: RECOMMENDED VDD VS. RANGE

Min. VDD, TSRNG = 1	Min. VDD, TSRNG = 0			
3.6V	1.8V			

16.3 Temperature Output

The output of the circuit is measured using the internal Analog-to-Digital Converter. A channel is reserved for the temperature circuit output. Refer to **Section 17.0 "Analog-to-Digital Converter (ADC) Module"** for detailed information.

16.4 ADC Acquisition Time

To ensure accurate temperature measurements, the user must wait at least 200 μ s after the ADC input multiplexer is connected to the temperature indicator output before the conversion is performed. In addition, the user must wait 200 μ s between sequential conversions of the temperature indicator output.

22.3 Timer1 Prescaler

Timer1 has four prescaler options allowing 1, 2, 4 or 8 divisions of the clock input. The T1CKPS bits of the T1CON register control the prescale counter. The prescale counter is not directly readable or writable; however, the prescaler counter is cleared upon a write to TMR1H or TMR1L.

22.4 Timer1 Oscillator

A dedicated low-power 32.768 kHz oscillator circuit is built-in between pins T1OSI (input) and T1OSO (amplifier output). This internal circuit is to be used in conjunction with an external 32.768 kHz crystal.

The oscillator circuit is enabled by setting the T1OS-CEN bit of the T1CON register. The oscillator will continue to run during Sleep.

Note: The oscillator requires a start-up and stabilization time before use. Thus, T1OSCEN should be set and a suitable delay observed prior to using Timer1. A suitable delay similar to the OST delay can be implemented in software by clearing the TMR1IF bit then presetting the TMR1H:TMR1L register pair to FC00h. The TMR1IF flag will be set when 1024 clock cycles have elapsed, thereby indicating that the oscillator is running and reasonably stable.

22.5 Timer1 Operation in Asynchronous Counter Mode

If the control bit T1SYNC of the T1CON register is set, the external clock input is not synchronized. The timer increments asynchronously to the internal phase clocks. If the external clock source is selected then the timer will continue to run during Sleep and can generate an interrupt on overflow, which will wake-up the processor. However, special precautions in software are needed to read/write the timer (see Section 22.5.1 "Reading and Writing Timer1 in Asynchronous Counter Mode").

Note:	When switching from synchronous to
	asynchronous operation, it is possible to
	skip an increment. When switching from
	asynchronous to synchronous operation,
	it is possible to produce an additional
	increment.

22.5.1 READING AND WRITING TIMER1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L while the timer is running from an external asynchronous clock will ensure a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself, poses certain problems, since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers, while the register is incrementing. This may produce an unpredictable value in the TMR1H:TMR1L register pair.

22.6 Timer1 Gate

Timer1 can be configured to count freely or the count can be enabled and disabled using Timer1 gate circuitry. This is also referred to as Timer1 Gate Enable.

Timer1 gate can also be driven by multiple selectable sources.

22.6.1 TIMER1 GATE ENABLE

The Timer1 Gate Enable mode is enabled by setting the TMR1GE bit of the T1GCON register. The polarity of the Timer1 Gate Enable mode is configured using the T1GPOL bit of the T1GCON register.

When Timer1 Gate Enable mode is enabled, Timer1 will increment on the rising edge of the Timer1 clock source. When Timer1 Gate Enable mode is disabled, no incrementing will occur and Timer1 will hold the current count. See Figure 22-3 for timing details.

TABLE 22-3: TIMER1 GATE ENABLE SELECTIONS

T1CLK	T1GPOL	T1G	Timer1 Operation		
\uparrow	0	0	Counts		
\uparrow	0	1	Holds Count		
\uparrow	1	0	Holds Count		
1	1	1	Counts		

22.6.2 TIMER1 GATE SOURCE SELECTION

Timer1 gate source selections are shown in Table 22-4. Source selection is controlled by the T1GSS bits of the T1GCON register. The polarity for each available source is also selectable. Polarity selection is controlled by the T1GPOL bit of the T1GCON register.

TABLE 22-4:	TIMER1	GATE	SOURCES
-------------	--------	------	---------

T1GSS	Timer1 Gate Source
00	Timer1 Gate Pin
01	Overflow of Timer0 (TMR0 increments from FFh to 00h)
10	Comparator 1 Output sync_C1OUT (optionally Timer1 synchronized output)
11	Comparator 2 Output sync_C2OUT (optionally Timer1 synchronized output)

22.6.2.1 T1G Pin Gate Operation

The T1G pin is one source for Timer1 gate control. It can be used to supply an external source to the Timer1 gate circuitry.

22.6.2.2 Timer0 Overflow Gate Operation

When Timer0 increments from FFh to 00h, a low-to-high pulse will automatically be generated and internally supplied to the Timer1 gate circuitry.

22.6.2.3 Comparator C1 Gate Operation

The output resulting from a Comparator 1 operation can be selected as a source for Timer1 gate control. The Comparator 1 output (sync_C1OUT) can be synchronized to the Timer1 clock or left asynchronous. For more information see **Section 20.4.1 "Comparator Output Synchronization"**.

22.6.2.4 Comparator C2 Gate Operation

The output resulting from a Comparator 2 operation can be selected as a source for Timer1 gate control. The Comparator 2 output (sync_C2OUT) can be synchronized to the Timer1 clock or left asynchronous. For more information see **Section 20.4.1 "Comparator Output Synchronization**".

22.6.3 TIMER1 GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a Timer1 gate signal, as opposed to the duration of a single level pulse.

The Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. See Figure 22-4 for timing details.

Timer1 Gate Toggle mode is enabled by setting the T1GTM bit of the T1GCON register. When the T1GTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

Note:	Enabling Toggle mode at the same time							
	as changing the gate polarity may result in							
	indeterminate operation.							

22.6.4 TIMER1 GATE SINGLE-PULSE MODE

When Timer1 Gate Single-Pulse mode is enabled, it is possible to capture a single-pulse gate event. Timer1 Gate Single-Pulse mode is enabled by first setting the T1GSPM bit in the T1GCON register. Next, the T1GGO/DONE bit in the T1GCON register must be set. The Timer1 will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the T1GGO/DONE bit will automatically be cleared. No other gate events will be allowed to increment Timer1 until the T1GGO/DONE bit is once again set in software. See Figure 22-5 for timing details.

If the Single-Pulse Gate mode is disabled by clearing the T1GSPM bit in the T1GCON register, the T1GGO/DONE bit should also be cleared.

Enabling the Toggle mode and the Single-Pulse mode simultaneously will permit both sections to work together. This allows the cycle times on the Timer1 gate source to be measured. See Figure 22-6 for timing details.

22.6.5 TIMER1 GATE VALUE

When Timer1 Gate Value Status is utilized, it is possible to read the most current level of the gate control value. The value is accessible by reading the T1GVAL bit in the T1GCON register. The T1GVAL bit is valid even when the Timer1 gate is not enabled (TMR1GE bit is cleared).

22.6.6 TIMER1 GATE EVENT INTERRUPT

When Timer1 Gate Event Interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of T1GVAL occurs, the TMR1GIF flag bit in the PIR1 register will be set. If the TMR1GIE bit in the PIE1 register is set, then an interrupt will be recognized.

The TMR1GIF flag bit operates even when the Timer1 gate is not enabled (TMR1GE bit is cleared).

23.0 TIMER2 MODULE

The Timer2 module incorporates the following features:

- 8-bit Timer and Period registers (TMR2 and PR2, respectively)
- Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4, 1:16, and 1:64)
- Software programmable postscaler (1:1 to 1:16)
- Interrupt on TMR2 match with PR2
- Optional use as the shift clock for the MSSP module

See Figure 23-1 for a block diagram of Timer2.



FIGURE 23-1: TIMER2 BLOCK DIAGRAM

REGISTER 24-31: PSMCxSTR0: PSMC STEERING CONTROL REGISTER 0

bit 1	PxSTRB: PWM Steering PSMCxB Output Enable bit
	If PxMODE<3:0> = 0000 (Single-phase PWM):1 = Single PWM output is active on pin PSMCxOUT10 = Single PWM output is not active on pin PSMCxOUT1. PWM drive is in inactive state
	<u>If PxMODE<3:0> = 0001 (Complementary Single-phase PWM):</u> 1 = Complementary PWM output is active on pin PSMCxB 0 = Complementary PWM output is not active on pin PSMCxB. PWM drive is in inactive state
	IF PxMODE<3:0> = 1100 (3-phase Steering):(1)1 = PSMCxA and PSMCxF are high. PSMCxB, PMSCxC, PSMCxD and PMSCxE are low.0 = 3-phase output combination is not active
bit 0	PxSTRA: PWM Steering PSMCxA Output Enable bit If PxMODE<3:0> = 000x (Single-phase PWM or Complementary PWM):
	 Single PWM output is active on pin PSMCxA Single PWM output is not active on pin PSMCxA. PWM drive is in inactive state
	 <u>IF PxMODE<3:0> = 1100 (3-phase Steering)</u>:⁽¹⁾ 1 = PSMCxA and PSMCxD are high. PSMCxB, PMSCxC, PSMCxE and PMSCxF are low. 0 = 3-phase output combination is not active

- **Note 1:** In 3-phase Steering mode, only one PSTRx bit should be set at a time. If more than one is set, then the lowest bit number steering combination has precedence.
 - **2:** These bits are not implemented on PSMC2.

25.0 CAPTURE/COMPARE/PWM MODULES

The Capture/Compare/PWM module is a peripheral that allows the user to time and control different events, and to generate Pulse-Width Modulation (PWM) signals. In Capture mode, the peripheral allows the timing of the duration of an event. The Compare mode allows the user to trigger an external event when a predetermined amount of time has expired. The PWM mode can generate Pulse-Width Modulated signals of varying frequency and duty cycle.

This family of devices contains two standard Capture/Compare/PWM modules (CCP1, CCP2 and CCP3).

The Capture and Compare functions are identical for all CCP modules.

- Note 1: In devices with more than one CCP module, it is very important to pay close attention to the register names used. A number placed after the module acronym is used to distinguish between separate modules. For example, the CCP1CON and CCP2CON control the same operational aspects of two completely different CCP modules.
 - 2: Throughout this section, generic references to a CCP module in any of its operating modes may be interpreted as being equally applicable to CCPx module. Register names, module signals, I/O pins, and bit names may use the generic designator 'x' to indicate the use of a numeral to distinguish a particular module, when required.

25.4 Register Definitions: CCP Control

REGISTER 25-1: CCPxCON: CCPx CONTROL REGISTER

U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
_	— — DCxB<1:0>			CCPx	Л<3:0>		
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'	
u = Bit is uncha	anged	x = Bit is unkn	iown	-n/n = Value a	t POR and BO	R/Value at all o	other Reset
'1' = Bit is set		'0' = Bit is clea	ared				
bit 7-6	Unimplement	ted: Read as '	כי				
bit 5-4	DCxB<1:0>:	PWM Duty Cyc	cle Least Signi	ficant bits			
	Capture mode Unused	<u>).</u>					
	Compare mod	<u>de:</u>					
	PWM mode:						
	These bits are	e the two LSbs	of the PWM d	uty cycle. The e	eight MSbs are	found in CCPF	RxL.
bit 3-0	CCPxM<3:0>	: CCPx Mode	Select bits				
	11xx = PWM	mode					
	1011 = Comp ADC	pare mode: Aut module is enat	o-conversion bled) ⁽¹⁾	Trigger (sets C	CPxIF bit (CCF	2), starts ADC	conversion if
	1010 = Comp	oare mode: gen	erate software	e interrupt only			
	1001 = Comp	are mode: clea	ar output on co	ompare match (set CCPxIF)		
	1000 = Comp	bare mode: set	output on com	npare match (se	et CCPxIF)		
	0111 = Capt u	ire mode: ever	y 16th rising e	dge			
	0110 = Captu	ire mode: ever	y 4th rising ed	ge			
	0101 = Captu	ire mode: ever	y rising edge				
			y raining euge				
	0011 = Reser	rved					
	0010 = Compare mode: toggle output on						
	0001 = Reser	rved			N		
	0000 = Captu	ire/Compare/P	vvivi off (resets	S CCPX module)		

The I²C interface supports the following modes and features:

- · Master mode
- Slave mode
- Byte NACKing (Slave mode)
- · Limited multi-master support
- 7-bit and 10-bit addressing
- · Start and Stop interrupts
- Interrupt masking
- Clock stretching
- · Bus collision detection
- · General call address matching
- Address masking
- · Address Hold and Data Hold modes
- Selectable SDA hold times

Figure 26-2 is a block diagram of the I^2C interface module in Master mode. Figure 26-3 is a diagram of the I^2C interface module in Slave mode.

FIGURE 26-2: MSSP BLOCK DIAGRAM (I²C[™] MASTER MODE)



26.5.4 SLAVE MODE 10-BIT ADDRESS RECEPTION

This section describes a standard sequence of events for the MSSP module configured as an I^2C slave in 10-bit Addressing mode.

Figure 26-19 is used as a visual reference for this description.

This is a step by step process of what must be done by slave software to accomplish I²C communication.

- 1. Bus starts Idle.
- Master sends Start condition; S bit of SSPSTAT is set; SSP1IF is set if interrupt on Start detect is enabled.
- 3. Master sends matching high address with R/W bit clear; UA bit of the SSPSTAT register is set.
- 4. Slave sends ACK and SSP1IF is set.
- 5. Software clears the SSP1IF bit.
- 6. Software reads received address from SSPBUF clearing the BF flag.
- 7. Slave loads low address into SSPADD, releasing SCL.
- 8. Master sends matching low address byte to the slave; UA bit is set.

Note: Updates to the SSPADD register are not allowed until after the ACK sequence.

- 9. Slave sends ACK and SSP1IF is set.
- **Note:** If the low address does not match, SSP1IF and UA are still set so that the slave software can set SSPADD back to the high address. BF is not set because there is no match. CKP is unaffected.
- 10. Slave clears SSP1IF.
- 11. Slave reads the received matching address from SSPBUF clearing BF.
- 12. Slave loads high address into SSPADD.
- Master clocks a data byte to the slave and clocks out the slaves ACK on the 9th SCL pulse; SSP1IF is set.
- 14. If SEN bit of SSPCON2 is set, CKP is cleared by hardware and the clock is stretched.
- 15. Slave clears SSP1IF.
- 16. Slave reads the received byte from SSPBUF clearing BF.
- 17. If SEN is set the slave sets CKP to release the SCL.
- 18. Steps 13-17 repeat for each received byte.
- 19. Master sends Stop to end the transmission.

26.5.5 10-BIT ADDRESSING WITH ADDRESS OR DATA HOLD

Reception using 10-bit addressing with AHEN or DHEN set is the same as with 7-bit modes. The only difference is the need to update the SSPADD register using the UA bit. All functionality, specifically when the CKP bit is cleared and SCL line is held low are the same. Figure 26-20 can be used as a reference of a slave in 10-bit addressing with AHEN set.

Figure 26-21 shows a standard waveform for a slave transmitter in 10-bit Addressing mode.

FIGURE 27-2: EUSART RECEIVE BLOCK DIAGRAM



The operation of the EUSART module is controlled through three registers:

- Transmit Status and Control (TXSTA)
- Receive Status and Control (RCSTA)
- Baud Rate Control (BAUDCON)

These registers are detailed in Register 27-1, Register 27-2 and Register 27-3, respectively.

When the receiver or transmitter section is not enabled then the corresponding RX or TX pin may be used for general purpose input and output.

31.0 DC AND AC CHARACTERISTICS GRAPHS AND CHARTS

The graphs and tables provided in this section are for **design guidance** and are **not tested**.

In some graphs or tables, the data presented are **outside specified operating range** (i.e., outside specified VDD range). This is for **information only** and devices are ensured to operate properly only within the specified range.

Unless otherwise noted, all graphs apply to both the F and LF devices.

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

"Typical" represents the mean of the distribution at 25°C. "Maximum", "Max.", "Minimum" or "Min." represents (mean + 3σ) or (mean - 3σ) respectively, where σ is a standard deviation, over each temperature range.

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	1.27 BSC			
Contact Pad Spacing	С		9.40	
Contact Pad Width (X28)	Х			0.60
Contact Pad Length (X28)	Y			2.00
Distance Between Pads	Gx	0.67		
Distance Between Pads	G	7.40		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

44-Lead Plastic Quad Flat, No Lead Package (ML) - 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	44		
Pitch	е	0.65 BSC		
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.20 REF		
Overall Width	E	8.00 BSC		
Exposed Pad Width	E2	6.25	6.45	6.60
Overall Length	D	8.00 BSC		
Exposed Pad Length	D2	6.25	6.45	6.60
Terminal Width	b	0.20	0.30	0.35
Terminal Length	L	0.30	0.40	0.50
Terminal-to-Exposed-Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension. usually without tolerance. for information purposes only.

Microchip Technology Drawing C04-103C Sheet 2 of 2